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TSORNG et al.(10) **Pub. No.: US 2022/0377923 A1**(43) **Pub. Date: Nov. 24, 2022**(54) **TOP COVER SYSTEM FOR A COMPUTER CHASSIS**(52) **U.S. Cl.**CPC **H05K 7/1418** (2013.01); **H05K 7/1489** (2013.01)(71) Applicant: **QUANTA COMPUTER INC.**,
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(57)

ABSTRACT

A chassis for a computing device includes a base component and a top cover. The base component includes guide slots therein. The top cover includes stamped protrusions extending from one or more side slider structures. The slider structures extend downwardly from a top surface of the top cover. The stamped protrusions are unitary one-piece structures with the one or more side slider structures. The stamped protrusions correspond to respective guide slots of the base component such that the stamped protrusions are positioned in corresponding guide slots when the base component and the top cover are in a mating position.

